Data Sheets of AVA Technology Chip Type White LED

Model : S381206

AVA Technology CO., LTD.

2640 S. Myrtle Ave. Suite 6 Monrovia, CA 91016, USA

P: 626-574-7726 F: 626-574-7732 http://www.led4life.com

Power Side Lighting LED with Reflector

1. FEATURES

High intensity with small package, ideal for backlighting Wide viewing angle (115°) Package Outline (L×W×H)= 3.8×1.2×0.60 mm Technology : InGaN Zener Protect package Color coordinates CIE(x,y) : (0.30,0.30) according to CIE 1931. Suitable for all SMT assembly methods Suitable for all soldering methods Suitable for Pb free process Delivery on 8 mm tape reels

2. APPLICATIONS

Automotive: indoor lighting. Signal and symbol lightings Backlighting (mobile phones, displays, PDA, Digital Camera.....) All applications in notice high intensities are required

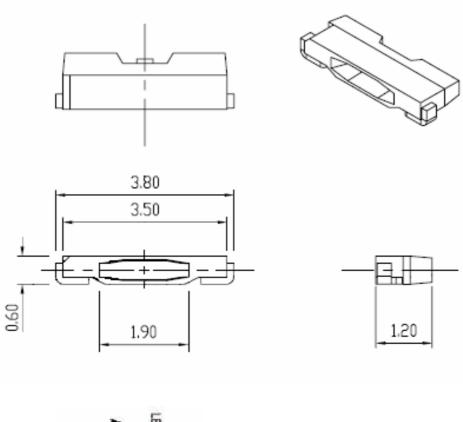
3. DEVICES PACKAGE

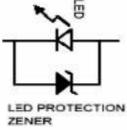
ITEM	MATERIALS		
Package Heat-Resistant Polymer			
Encapsulating	Heat Resistance Resin		
Electrodes	Ag Plating Copper Alloy		

Туре	Color of Emission	Color of the Light Emitting Area	Luminous intensity Iv (mcd) I _F =15mA		
S381206	White	Colored	610 ~ 1290		



4. OUTLINE DIMENSION:





Note: 1. Unit: mm 2. Tolerance: Dimension ± 0.1 / Angle ± 0.5°

Parameter Symbol **Absolute Max. Rating** Unit Forward Current I_{F} 25 mA -30 ~ +85 °C **Operating Temperature** Topr °C -40 ~ +100 Storage Temperature T_{stg} °C Soldering Temperature T_{sol} 260 (for 5 sec) 90 mW **Power Dissipation** P_{D} Peak Forward Current 60 mA I_{F(peak)} (Duty 1/10 @ 1KHz) Junction temperature Τj 100 °C Thermal Resistance 750 °C/W R_{th, JA} (Junction to ambient)

5. ABSOLUTE MAXIMUM RATINGS (Ta=25 $^\circ\!\!\mathbb{C}$)

6. ELECTRONIC OPTICAL CHARACTERISTICS

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Chromaticity coordinate x acc. To CIE 1931	Х	I _F =15mA		0.30		
Chromaticity coordinate y acc. To CIE 1931	У	I _F =15mA		0.30		
Viewing Angle	2 heta 1/2	I _F =15mA		115		Degree
Forward Voltage	$V_{\rm F}$	I _F =15mA		3.2	3.5	V
Forward Resistance(Note 1)	$R_{\rm F}$		4.0			MΩ
Forward Resistance (Note 2)	$R_{\rm F}$		20			MΩ
Forward Resistance (Note 3)	R _F					MΩ

Note 1 : Special specification for P/N : S381206-MZ-F only.

Note 2 : Special specification for P/N : S381206-M2Z-F only.

Note 3 : Special specification for P/N : S381206-Z-F only



7. LUMINOUS INTENSITY GROUPS:

Iv Bin	Measurement condition	Luminous intensity Iv(mcd)			
T211F		610-650			
T212F		650-690			
T221F		690-730			
T222F		730-770			
U11F		770-810			
U12F		810-850			
U13F		850-890			
U14F		890-930			
U15F	$I_F = 15 \text{ mA}$	930-970			
U16F		970-1010			
U21F		1010-1050			
U22F		1050-1090			
U23F		1090-1130			
U24F		1130-1170			
U25F		1170-1210			
U26F		1210-1250			
U27F	1	1250-1290			

* Luminous intensity group includes 17 groups T211F to U27F.

* Luminous intensity is tested at a current pulse duration of 25ms and a tolerance of $\pm 10\%$.



8. CHROMATICITY COORDINATES :

* CIE(x,y) Ranks

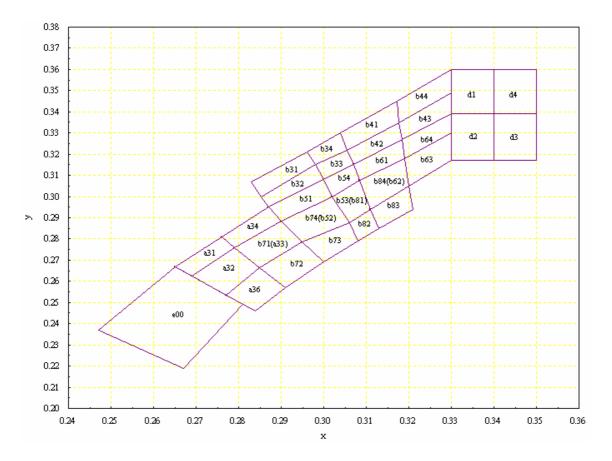
Forward Current, IF=15mA											
	C	IE		C	IE		CIE			CIE	
Rank	х	у	Rank	х	у	Rank	х	у	Rank	х	У
	0.2650	0.2670	b74	0.2900	0.2885	b63	0.3190	0.3180	b43	0.3177	0.3350
a31	0.2690	0.2625		0.2950	0.2785		0.3200	0.3050		0.3185	0.3270
u.5 1	0.2790	0.2760	(b52)	0.3060	0.2875		0.3300	0.3170		0.3300	0.3390
	0.2760	0.2810		0.3020	0.3000		0.3300	0.3300		0.3300	0.3490
	0.2690	0.2625		0.3060	0.2875	b64	0.3185	0.3270	b44	0.3172	0.3452
a32	0.2770	0.2535	b82	0.3080	0.2790		0.3190	0.3180		0.3177	0.3350
a32	0.2850	0.2665	002	0.3130	0.2850	00-	0.3300	0.3300	044	0.3300	0.3490
	0.2790	0.2760		0.3110	0.2940		0.3300	0.3390		0.3300	0.3600
	0.2790	0.2760		0.3110	0.2940		0.2830	0.3070		0.3300	0.3600
a33	0.2850	0.2665	b83	0.3130	0.2850	b31	0.2853	0.3000	d 1	0.3300	0.3390
(b71)	0.2950	0.2785	005	0.3210	0.2940	0.51	0.2980	0.3150	uı	0.3400	0.3390
	0.2900	0.2885		0.3200	0.3050		0.2960	0.3210		0.3400	0.3600
	0.2760	0.2810	b84 (b62)	0.3085	0.3075	b32	0.2853	0.3000	d2	0.3300	0.3390
a34	0.2790	0.2760		0.3110	0.2940		0.2870	0.2950		0.3300	0.3170
a34	0.2900	0.2885		0.3200	0.3050		0.3000	0.3080		0.3400	0.3170
	0.2870	0.2950		0.3190	0.3180		0.2980	0.3150		0.3400	0.3390
	0.2770	0.2535		0.2870	0.2950	b33	0.2980	0.3150	d3	0.3400	0.3390
a36	0.2840	0.2460	b51	0.2900	0.2885		0.3000	0.3080		0.3400	0.3170
a30	0.2910	0.2570		0.3020	0.3000		0.3070	0.3150		0.3500	0.3170
	0.2850	0.2665		0.3000	0.3080		0.3055	0.3220		0.3500	0.3390
	0.2470	0.2370		0.3020	0.3000		0.2960	0.3210		0.3400	0.3600
e00	0.2670	0.2190	b53	0.3060	0.2875	b34	0.2980	0.3150	d4	0.3400	0.3390
000	0.2810	0.2490	(b81)	0.3110	0.2940	0.54	0.3055	0.3220		0.3500	0.3390
	0.2650	0.2670		0.3085	0.3075		0.3040	0.3300		0.3500	0.3600
	0.2850	0.2665		0.3000	0.3080		0.3040	0.3300			
b72	0.2910	0.2570	b54	0.3020	0.3000	b41	0.3055	0.3220			
072	0.3000	0.2690		0.3085	0.3075		0.3177	0.3350			
	0.2950	0.2785		0.3070	0.3150		0.3172	0.3452			
	0.2950	0.2785	- b61	0.3070	0.3150	b42	0.3055	0.3220			
b73	0.3000	0.2690		0.3085	0.3075		0.3070	0.3150			
015	0.3080	0.2790		0.3190	0.3180		0.3185	0.3270			
	0.3060	0.2875		0.3185	0.3270		0.3177	0.3350			

* CIE rank can be sorted by 0.008~0.015
* Tolerance of the chromaticity coordinate is ±0.007

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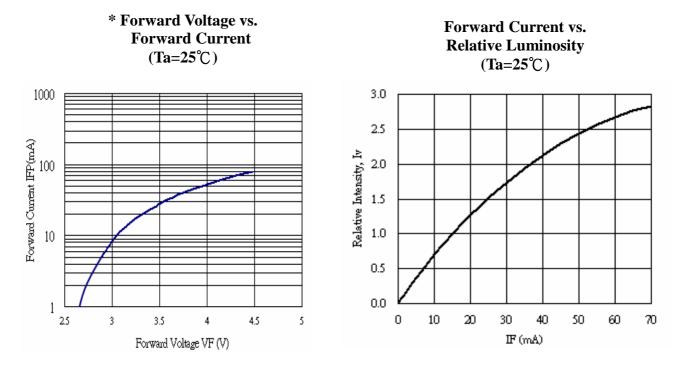
* Chromaticity Coordinates (CIE 1931 system)



9. FORWARD VOLTAGE

I _F @ 15mA				
Bin	VF(Volt)			
Vb	2.80-2.90			
Va	2.90-3.00			
V0	3.00-3.10			
V1	3.10-3.20			
V2	3.20-3.30			
V3	3.30-3.40			

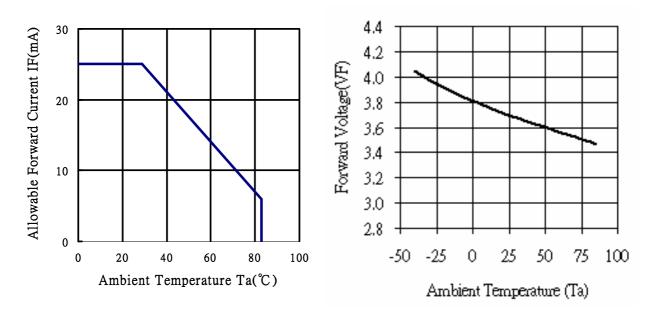
*VF tolerance $\pm 0.05V$

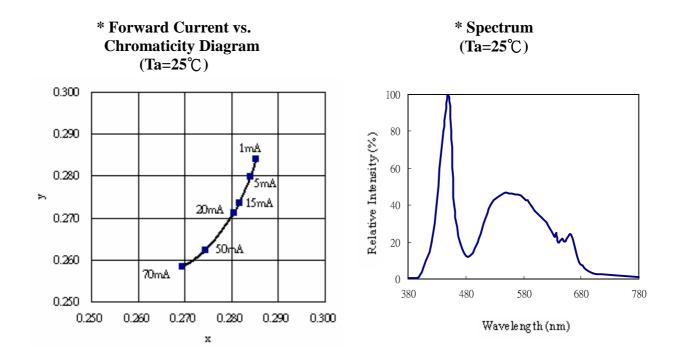


* Ambient Temperature vs. Allowable Forward Current

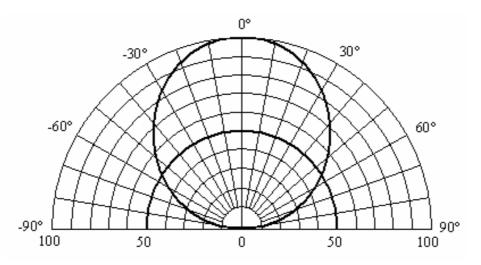
* Ambient Temperature vs. Forward Voltage

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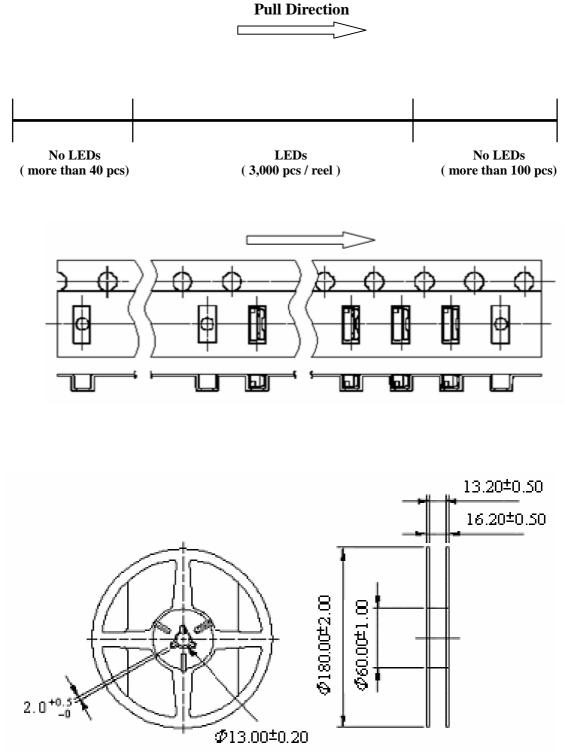
* Radiation Characteristic (@ 25°C, 15mA)



Relative Luminous Intensity (%)



11. REEL PACKAGE:



Note: 1. Unit: mm 2. 3,000 pcs / reel

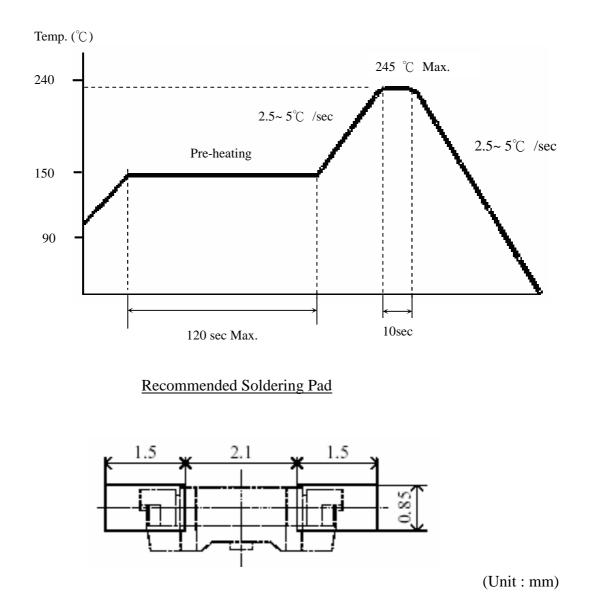
12. RELIABILITY PLAN:

* The reliability of products shall be satisfied with items listed below. Confidence Level : 90 % , LTPD : 10 %

No	Test Item	Description & Conditi	Sample size	Ac/Re	Failure Criteria	
1	Solderability	Tsld =245±5°C, 10sec,	1 time	22	0/1	
2	Room Temperature operating	$Ta = 25 \ ^{\circ}C$ $I_{F} = 20mA$	1000 hrs	22	0/1	$IV < L* \ 0.6 \\ (I_F: \ 20mA)$
3	Room Temperature operating	$Ta = 25 \ ^{\circ}C$ $I_{F} = 30mA$	500 hrs	22	0/1	$V_{F} > U * 1.1$ (I _F : 20mA)
4	Low Temperature Storage	$Ta = -40 \ ^{\circ}C$	1000 hrs	22	0/1	$I_R > U * 2.0$ (V _R :5V)
5	High Temperature Storage	Ta = 100 °C	1000 hrs	22	0/1	L: Lower Spec. Level
6	Temperature Cycle	-40°C ~ 25°C ~ 100°C ~ 25 °C 30min 5min 30min 5 min	100 cycles	22	0/1	U: Upper Spec. Level
7	High Humidity Heat	$Ta = 60 \ ^{\circ}C$ RH=90% $I_{F} = 15mA$	500 hrs	22	0/1	

13. SOLDERING CONDITIONS:

(1) Recommended Re-flow profile



- (2) Re-flow soldering should not be done more than two times.
- (3) It is recommended that the user use the nitrogen reflow method.
- (4) When soldering, don't put stress on the LEDs during heating.
- (5) After soldering, don't warp the circuit board.
- (6) It is recommended that isopropyl alcohol (IPA) be used as a solvent for cleaning the LEDs.

14.CAUTIONS:

(1)Storage

• Before opening the package :

The LEDs should be kept at 30° C or less and 30%RH~85%RH. The LEDs should be used within a year. When storing the LEDs, moisture proof packaging with desiccant (Silica gel)is recommended.

• After opening the package :

The LEDs should be kept at 30° C or less and 30° RH-70 $^{\circ}$ RH.The LEDs should be soldered within 168hours (7days) after opening the package. If unused LEDs remain, they should be stored in moisture proof packages, such as sealed containers with packages of moisture desiccant (Silica ge1), or reseal the moisture proof bag again.

If the moisture desiccant (Silica ge1) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment: more than 24 hours at 65° C.

Please avoid conditions which may cause the LED to corrode, tarnish or discolor. This corrosion or discoloration might lower solderability or might effect on optical characteristics. Please avoid rapid transitions in ambient temperature, especially in high humidity environments where condensation can occur.

Moisture Proof package

When moisture is absorbed into the SMT package it may vaporize and expand during soldering. There is a possibility that this can cause exfoliation of the contacts and damage to the optical characteristics of the LEDs. For this reason, the moisture proof package is used to keep moisture to a minimum in the package. A package of a moisture desiccant (silica gel)is inserted into the moisture proof bag. The silica gel changes its color from blue to pink as it absorbs moisture.

(2)Static Electricity

- Static electricity or surge voltage damages the LEDs. It is recommended that a wrist band or an anti-electrostatic glove and shoe be used when handling the LEDs.
- All devices, equipment and machinery must be properly grounded. It is recommended that measures be taken against surge voltage to the equipment that mounts the LEDs.
- When inspecting the final products in which LEDs were assembled, it is recommended to check whether the assembled LEDs are damaged by static electricity or not. It is easy to End static-damaged LEDs by a light-on test or a V_F test at a lower current (below l mA).
- Damaged LEDs will show some unusual characteristics such as the leak current remarkably increases, the forward voltage becomes lower, or the LEDs do not light at the low current. (Criteria : $V_F>2.0V$ at $I_F=0.5mA$.)

(3)Heat Generation

- Please consider the heat generation of the LED when making the system design that it's very importance. The coefficient of temperature increase per input electric power is affected by the thermal resistance of the circuit board and density of LED placement on the board, and other components. It is necessary to avoid intense heat generation and operate within the maximum ratings given in this specification.
- The operating current should be decided after considering the ambient maximum temperature of LEDs.



(4)Others

- Care must be taken to ensure that the reverse voltage will not exceed the absolute maximum rating when using the LEDs with matrix drive.
- The LED light output is strong enough to injure human eyes. Precautions must be taken to prevent looking directly for more than a few seconds. Flashing lights have been known to cause discomfort in people; you can prevent this by taking precautions during use. Also, people should be cautious when using equipment that has had LEDs incorporated into it.



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